

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0432498919

Status:

Active

Overview:

modular_plugs_jacks

Description:

Modular Jack, Right Angle, Low Profile, 8/8, Panel Stops

Documents:

3D Model

Drawing (PDF)

Product Specification PSX-43249 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification

CSA

LR19980

UL

E107635

General

Product Family

Modular Jacks/Plugs

Series

43249

Component Type

PCB Jack

Magnetic

No

Overview

modular_plugs_jacks

Performance Category

3, 4

Power over Ethernet (PoE)

N/A

Product Name

RJ45

Physical

Boot Color

N/A

Color - Resin

Black

Durability (mating cycles max)

500

Flammability

94V-0

Inverted / Top Latch

No

Lightpipes/LEDs

None

Material - Metal

Phosphor Bronze

Material - Plating Mating

Gold

Material - Plating Termination

Tin

Material - Resin

High Temperature Thermoplastic

Orientation

Right Angle (Side Entry)

PCB Locator

Yes

PCB Retention

Yes

PCB Thickness Recommended (in)

0.062 In

PCB Thickness Recommended (mm)

1.57 mm

Packaging Type

Tray

Panel Mount

Without Flange

Pitch - Mating Interface (in)

0.040 In

Pitch - Mating Interface (mm)

1.02 mm

Pitch - Term. Interface (in)

0.050 In

Pitch - Term. Interface (mm)

1.27 mm

Plating min: Mating (µin)

50

Plating min: Mating (µm)

1.25

Plating min: Termination (µin)

100

Plating min: Termination (µm)

2.5

Ports

1

Positions / Loaded Contacts

8/8

Surface Mount Compatible (SMC)

Yes

Temperature Range - Operating

-40°C to +85°C

Termination Interface: Style

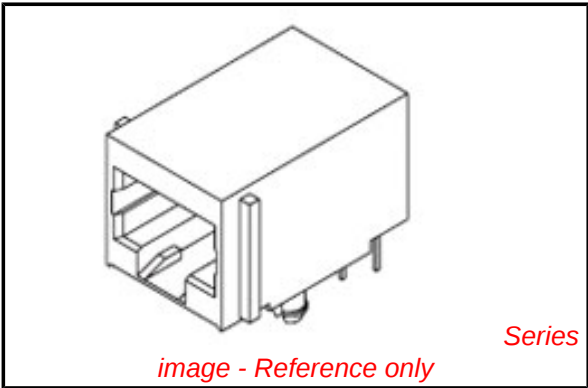
Through Hole

Waterproof / Dustproof

No

Wire/Cable Type

N/A



EU RoHS

ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status

Not Reviewed

Need more information on product
environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

China RoHS



Search Parts in this Series
43249Series

Mates With
FCC 68 Plugs

Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Grounding to Panel	Yes
Shielded	Yes
Voltage - Maximum	150V AC (RMS)

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-44050-004
Product Specification	PSX-43249
Sales Drawing	SDA-43249

This document was generated on 06/07/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
 INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
 TERMINALS: PHOSPHOR BRONZE, .012/(0.30) THICK
 SHIELD: BRASS, .007/(0.18) THICK

2) FINISH:

TERMINALS:

- A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
 *SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
 WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
 B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
 *SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
 WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.

SHIELD:

- *100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES /
 1.27 MICROMETERS COPPER UNDERPLATE, PCB GROUND TABS DIPPED IN TIN
 *THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
 DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
 CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
 IN THE PC TAILS AND/OR SHIELD.

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43249.

4) PACKAGING SPECIFICATION:

- UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
 PER MOLEX PACKAGING SPECIFICATION PK-43249-004.
 UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
 PER MOLEX PACKAGING SPECIFICATION PK-43249-005.
 SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
 PER MOLEX PACKAGING SPECIFICATION PK-44050-004.

5) MATES WITH: MODULAR PLUGS THAT CONFORM TO FCC REGULATION PART 68.5.

6) SEE SHEET 3 FOR SHIELDED JACK ASSEMBLY.

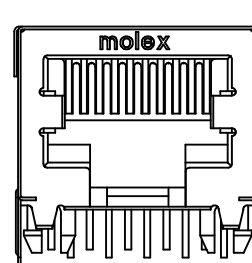
7) SEE SHEETS 5 & 6 FOR P.C. BOARD LAYOUTS.

8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

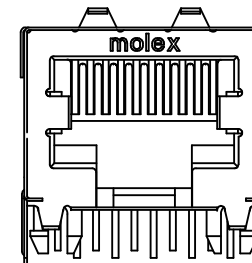
9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

10) THIS PART CONFORMS TO FCC REGULATION 68.5 AND TIA 1096 FOR MODULAR JACKS.

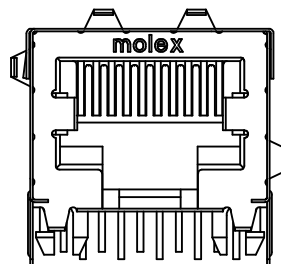
SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



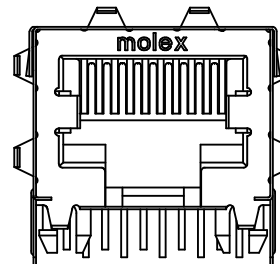
OPTION "A"
NO TOP OR SIDE TABS



OPTION "B"
TOP TABS

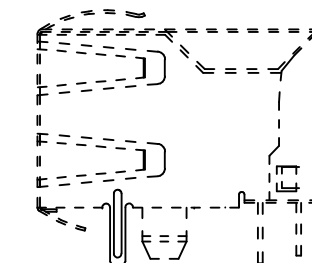


OPTION "C"
TOP AND STAGGERED SIDE TABS

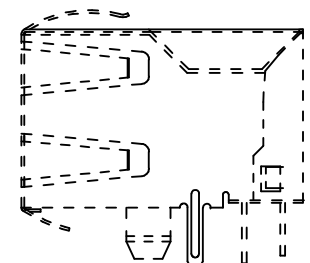


OPTION "D"
TOP AND SIDE TABS

BOTTOM PCB GROUND TAB OPTIONS FOR SHIELDS



OPTION "E"
OPTIONAL FRONT POSITION



OPTION "F"
OPTIONAL REAR POSITION

NOTE: EITHER PCB GROUND TAB OPTION IS AVAILABLE
ON ALL SIDE/TOP TAB CONFIGURATIONS

DRAWING LEGEND

- SHEET 1- NOTES, GROUND TAB OPTIONS
 SHEET 2- UNSHIELDED MODULAR JACK
 SHEET 3- SHIELDED MODULAR JACK WITH
 OPTIONAL SIDE/TOP GROUND TABS & BOTTOM GROUND
 TAB WITH OPTIONAL POSITION.
 SHEET 4- PART NUMBER CHARTS
 SHEET 5- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING
 SHEET 6- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING

ADDED NOTE 10 EC NO: UCP2009-0740 DRWN: KLOSTERNER 2008/09/29 CHKD: JEBELL 2008/10/03 APPR: FSMITH 2008/10/03 K1	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY		
				mm	INCH	DRAWN BY	DATE	TITLE				
			4 PLACES	± ---	± ---	JTR	1993/06/23	MOLEX INCORPORATED				
			3 PLACES	± ---	± .010	CHECKED BY	DATE					
			2 PLACES	± 0.25	± ---	JTR	1993/06/23					
			1 PLACE	± ---	± ---	APPROVED BY	DATE					
			ANGULAR ±1/2°		RAS	1993/06/23						
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.			DOCUMENT NO.			SHEET NO.	
					SEE SHEET 4			SDA-43249			1 OF 6	
					SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

UNSHIELDED MODULAR JACK

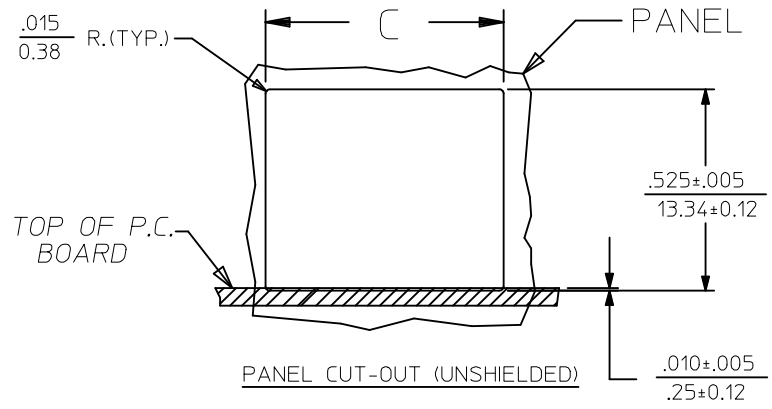
8 POSITION LOADED 10 SIZE SHOWN



OPTIONAL FLANGE
USED FOR FLUSH
MODULAR JACK



PEG DETAIL
SCALE 8:1

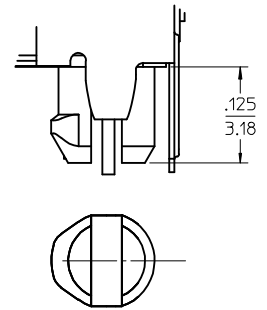
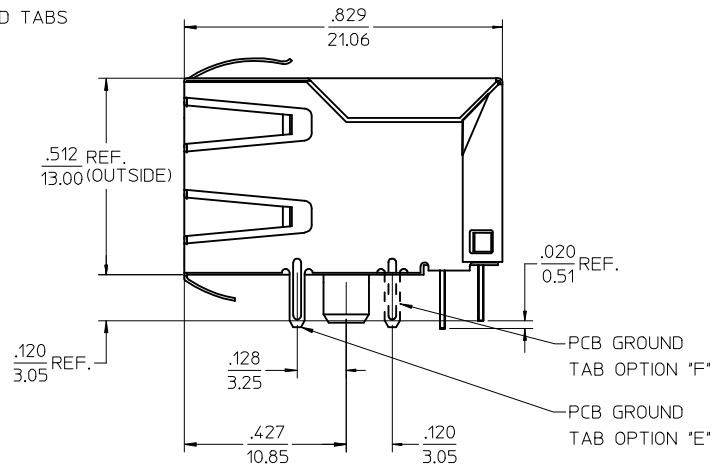
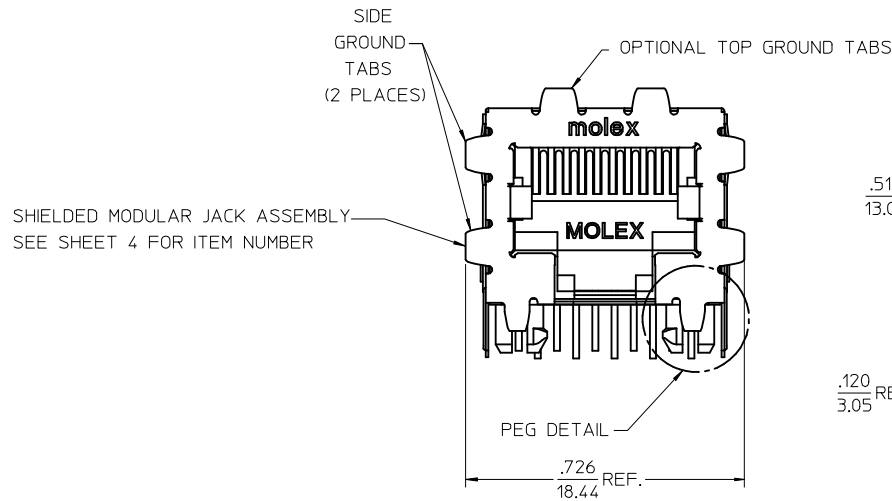


HOUSING SIZE	CIRCUIT SIZE	DIM. A	DIM. B	DIM. C
8	10	.600±.005 (15.24±0.13)	.450±.005 (11.43±0.13)	.620±.005 (15.75±0.13)
8	8	.600±.005 (15.24±0.13)	.350±.005 (8.89±0.13)	.620±.005 (15.75±0.13)
8	4	.600±.005 (15.24±0.13)	.150±.005 (3.81±0.13)	.620±.005 (15.75±0.13)
8	6	.600±.005 (15.24±0.13)	.250±.005 (6.35±0.13)	.620±.005 (15.75±0.13)
6	6	.520±.005 (13.21±0.13)	.250±.005 (6.35±0.13)	.540±.005 (13.72±0.13)
6	4	.520±.005 (13.21±0.13)	.150±.005 (3.81±0.13)	.540±.005 (13.72±0.13)
6	2	.520±.005 (13.21±0.13)	.050±.005 (1.27±0.13)	.540±.005 (13.72±0.13)

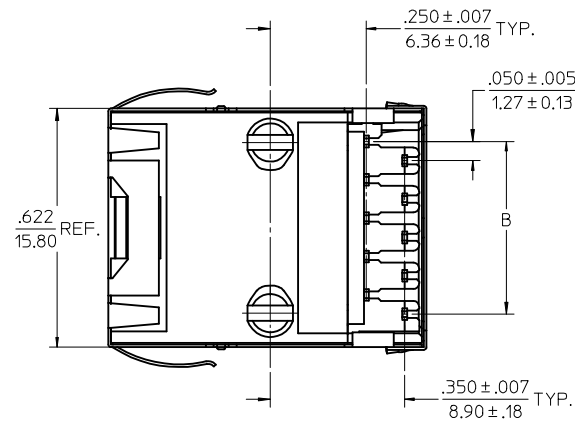
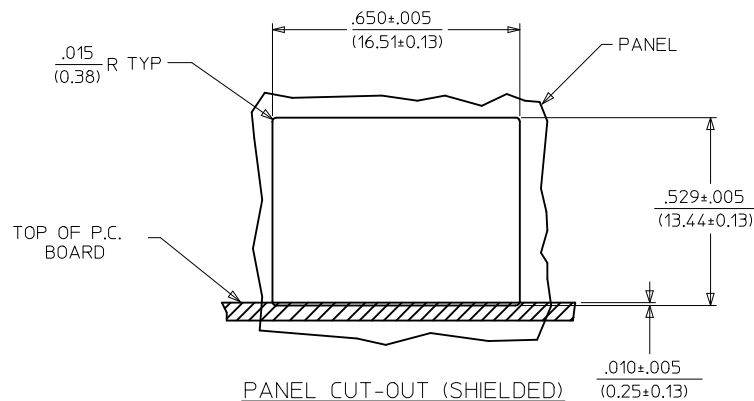
SEE SHEET 1 EC NO: UCP2009-0740 DRWN: JLOSTEME / ER 2008/09/29 CHKD: JBEL 2008/10/03 APPR: FSMITH 2008/10/03	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
		4 PLACES ± --- ± ---		DRAWN BY JTR		DATE 1993/06/23		TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	
		3 PLACES ± --- ± .010		CHECKED BY JTR		DATE 1993/06/23			
		2 PLACES ± 0.25 ± ---		APPROVED BY RAS		DATE 1993/06/23			
		1 PLACE ± --- ± ---		MATERIAL NO. RAS		DOCUMENT NO. SDA-43249			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 4		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

MODULAR JACK W/ .007" THICK SHIELD AND OPTIONAL GROUND TABS

8 LOADED 10 VERSION SHOWN WITH GROUND TAB OPTIONS "D" AND "E"



PEG DETAIL
SCALE 8:1



DESCRIPTION OF GROUND TAB OPTIONS:
(SEE SHEET 4 FOR AVAILABLE COMBINATIONS OF OPTIONS)

GROUND TAB OPTION	DESCRIPTION
A	NO GROUND TABS
B	TOP TABS ONLY
C	STAGGERED SIDE TABS
D	TOP AND SIDE TABS
E	PCB GROUND TAB IN FRONT POSITION
F	PCB GROUND TAB IN REAR POSITION

HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450 ± .005 11.43 ± 0.13
8	8	.350 ± .005 8.89 ± 0.13

SEE SHEET 1
EC NO: UCP2009-0740
DRWN: JKLOSTEMEIER 2008/09/29
CHKD: JEBEL 2008/10/03
APPR: FSMITH 2008/10/03

QUALITY SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±	---	---
3 PLACES ±	---	±.010
2 PLACES ±	0.25	---
1 PLACE ±	---	---

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM

DRAWN BY DATE
JTR 1993/06/23

CHECKED BY DATE
JTR 1993/06/23

APPROVED BY DATE
RAS 1993/06/23

MATERIAL NO.
SEE SHEET 4

SIZE
C

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE PROJECTION

TITLE
LOW PROFILE RIGHT ANGLE
MODULAR JACK ASSEMBLY

MOLEX INCORPORATED

DOCUMENT NO.
SDA-43249

SHEET NO.
3 OF 6

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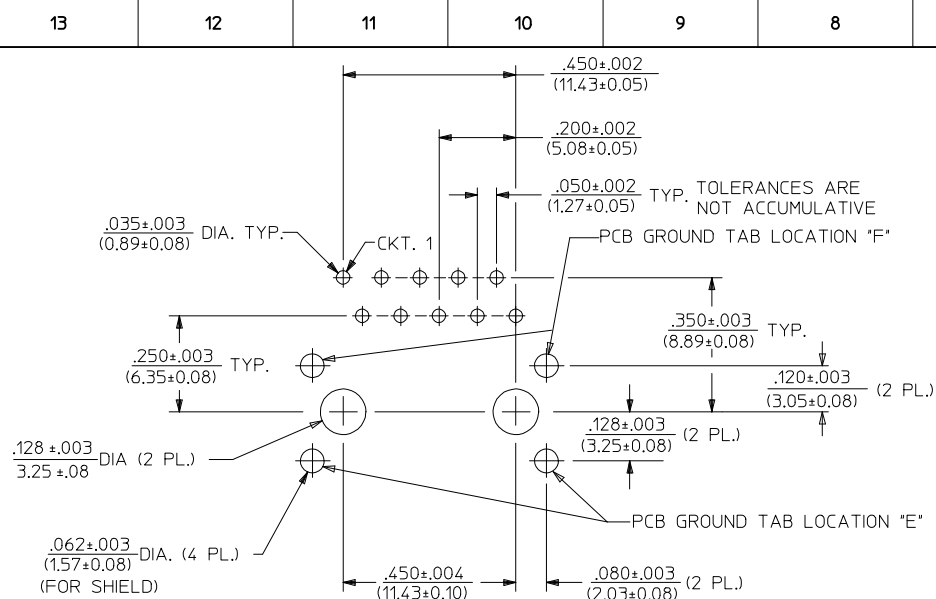
13	12	11	10	9	8	7	6	5	4	3	2	1
FLUSH MOUNT (UNSHIELDED)					SHIELDED, .007" THICK							
ASSEMBLY ITEM NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION		ASSEMBLY ITEM NUMBER	CONN. SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION		PACKAGING OPTION
43249-8001	8	10	A		43249-8900	8	10	A	A	E		TRAY
43249-8004	8	8	A		43249-8901	8	10	A	B	E		TRAY
43249-8010	8	6	A		43249-8902	8	10	A	C	E		TRAY
43249-6001	6	6	A		43249-8903	8	10	A	D	E		TRAY
43249-6004	6	4	A		43249-8908	8	10	A	A	F		TRAY
43249-6007	6	2	A		43249-8909	8	10	A	B	F		TRAY

FLANGELESS (UNSHIELDED)			
ASSEMBLY ITEM NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION
43249-8101	8	10	A
43249-8102	8	10	B
43249-8104	8	8	A
43249-8105	8	8	B
43249-8116	8	6	A
43249-8119	8	4	A
43249-6101	6	6	A
43249-6104	6	4	A
43249-6107	6	2	A

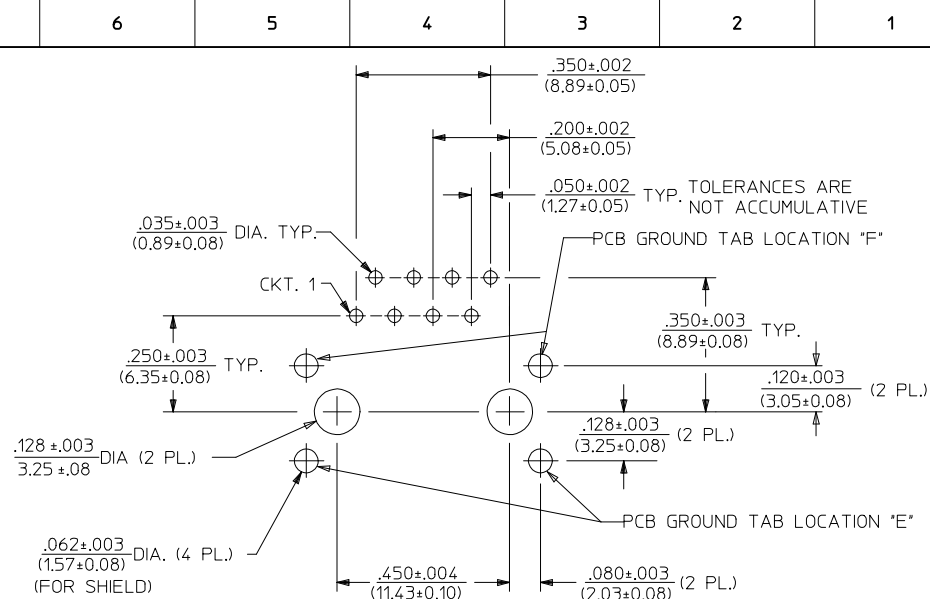
FLANGELESS (UNSHIELDED)			
(SHIPPED IN TUBES)			
43249-6501	6	6	A
43249-6504	6	4	A

SHIELDED, .007" THICK						
ASSEMBLY ITEM NUMBER	CONN. SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	PACKAGING OPTION
43249-8900	8	10	A	A	E	TRAY
43249-8901	8	10	A	B	E	TRAY
43249-8902	8	10	A	C	E	TRAY
43249-8903	8	10	A	D	E	TRAY
43249-8908	8	10	A	A	F	TRAY
43249-8909	8	10	A	B	F	TRAY
43249-8910	8	10	A	C	F	TRAY
43249-8911	8	10	A	D	F	TRAY
43249-8916	8	8	A	A	E	TRAY
43249-8917	8	8	A	B	E	TRAY
43249-8918	8	8	A	C	E	TRAY
43249-8919	8	8	A	D	E	TRAY
43249-8920	8	8	B	A	E	TRAY
43249-8924	8	8	A	A	F	TRAY
43249-8925	8	8	A	B	F	TRAY
43249-8926	8	8	A	C	F	TRAY
43249-8927	8	8	A	D	F	TRAY

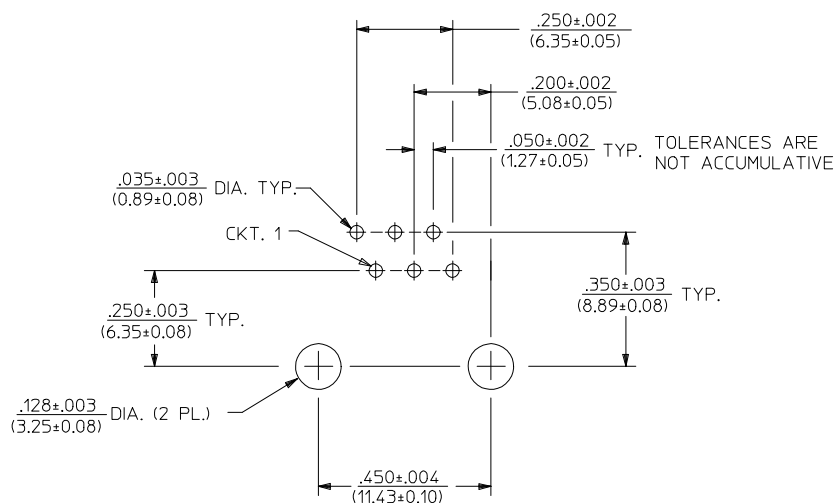
SEE SHEET 1 EC NO: UCP2009-0740 DRAWN: JLOSTEME 08/08/09/29 CHKD: JBELL 08/08/10/03 APPR: FSWITH 08/08/10/03	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		
		▽=0		mm	INCH	DRAWN BY JTR	DATE 1993/06/23	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY			
		▽=0	4 PLACES	±---	±---	CHECKED BY JTR	DATE 1993/06/23				
			3 PLACES	±---	±.010						
			2 PLACES	±0.25	±---						
			1 PLACE	±---	±---						
			ANGULAR ±1/2°								
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		DOCUMENT NO. SDA-43249		SHEET NO. 4 OF 6		
		REV				SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



PC BOARD LAYOUT FOR SIZE 8, 10 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 8, 8 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 8, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062 ± .005 / (1.57 ± 0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEMEIER 2008/09/29 CHKD: JRELL 2008/10/03 APPR: FSMITH 2008/10/03	DESCRIPTION K1	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		
				mm	INCH	DRAWN BY JTR		DATE 1993/06/23		TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	
			4 PLACES	± ---	± ---	CHECKED BY JTR		DATE 1993/06/23			
			3 PLACES	± ---	± .010	APPROVED BY RAS		DATE 1993/06/23			
			2 PLACES	± 0.25	± ---	MATERIAL NO.		DOCUMENT NO.		SHEET NO. 5 OF 6	
			1 PLACE	± ---	± ---	SEE SHEET 4		SDA-43249			
			ANGULAR ±1/2°			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

13 12 11 10 9 8 7 6 5 4 3 2 1



PC BOARD LAYOUT FOR SIZE 6, 6 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 4 CIRCUIT
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR SIZE 6, 2 CIRCUIT
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

SEE SHEET 1 EC NO: UCP2009-0740 DRWN: KLOSTEWIEC 2008/09/29 CHKD: JELL 2008/10/03 APPR: FSMITH 2008/10/03	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	mm	INCH	DRAWN BY	DATE	TITLE LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	
				4 PLACES ± ---	± ---	JTR	1993/06/23		
				3 PLACES ± ---	± .010	CHECKED BY	DATE		
				2 PLACES ± 0.25	± ---	JTR	1993/06/23		
				1 PLACE ± ---	± ---	APPROVED BY	DATE		
			ANGULAR ±1/2°		RAS	1993/06/23	 MOLEX INCORPORATED		
		MATERIAL NO.	DOCUMENT NO.	SHEET NO.					
K1	REV			SEE SHEET 4		SDA-43249		6 OF 6	
					SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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Факс: +7 495 668-12-70 (доб.304)

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moschip.ru_9